

ES_LPC2470_78

Errata sheet LPC2470/78

Rev. 8.1 — 1 July 2012

Errata sheet

Document information

Info	Content
Keywords	LPC2470FBD208; LPC2470FET208; LPC2478FBD208; LPC2478FET208, LPC2470/78 errata
Abstract	This errata sheet describes both the known functional problems and any deviations from the electrical specifications known at the release date of this document. Each deviation is assigned a number and its history is tracked in a table.



Revision history

Rev	Date	Description
8.1	20120701	Added VBAT.1.
8	20110601	Added USB.1.
7	20110420	Added Note.2.
6	20110301	Added ADC.1.
5	20100401	- The format of this errata sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. - Added Ethernet.1
4	20100209	Added date code info for IRC.2
3	20090814	Added IRC.2
2	20090511	Added Rev D
1	20081126	First version.

Contact information

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1. Product identification

The LPC2470/78 devices typically have the following top-side marking:

LPC247Xxxx

xxxxxxx

xxYYWWR[x]

The last/second to last letter in the third line (field 'R') will identify the device revision. This Errata Sheet covers the following revisions of the LPC2470/78:

Table 1. Device revision table

Revision identifier (R)	Revision description
'C'	Initial device revision
'D'	Second device revision

Field 'YY' states the year the device was manufactured. Field 'WW' states the week the device was manufactured during that year.

2. Errata overview

Table 2. Functional problems table

Functional problems	Short description	Revision identifier	Detailed description
ADC.1	External sync inputs not operational	'C', 'D'	Section 3.1
Core.1	Incorrect update of the Abort Link register in Thumb state	'C', 'D'	Section 3.2
Ethernet.1	Ethernet TxConsumeIndex register does not update correctly after the first frame is sent	'C', 'D'	Section 3.3
USB.1	USB host controller hangs on a dribble bit	'C', 'D'	Section 3.4
VBAT.1	The VBAT pin cannot be left floating	'C', 'D'	Section 3.5

Table 3. AC/DC deviations table

AC/DC deviations	Short description	Revision identifier	Detailed description
IRC.1	Accuracy of the Internal RC oscillator (IRC) frequency may be outside of the 4 MHz +/- 1 % specification only at extreme temperatures.	'C'	Section 4.1
IRC.2	Accuracy of the internal RC oscillator (IRC) frequency for devices only with date codes 0949 and before are outside of spec between -20 °C and -40 °C	'D'	Section 4.2

Table 4. Errata notes table

Errata notes	Short description	Revision identifier	Detailed description
Note.1	When the input voltage is $V_i \geq V_{DD} I/O + 0.5 \text{ V}$ on each of the following port pins P0.23, P0.24, P0.25, P0.26, P1.30, P1.31, P0.12, and P0.13 (configured as general purpose input pin (s)), current must be limited to less than 4 mA by using a series limiting resistor.	'C', 'D'	Section 5.1
Note.2	On the LPC2470/78 Rev D, design changes to the Memory Accelerator Module were made to enhance timing and general performance.	'D'	Section 5.2

3. Functional problems detail

3.1 ADC.1: External sync inputs not operational

Introduction:

In software-controlled mode (BURST bit is 0), the 10-bit ADC can start conversion by using the following options in the A/D Control Register:

26:24	START	When the BURST bit is 0, these bits control whether and when an A/D conversion is started:	0
	000	No start (this value should be used when clearing PDN to 0).	
	001	Start conversion now.	
	010	Start conversion when the edge selected by bit 27 occurs on P2.10/EINT0.	
	011	Start conversion when the edge selected by bit 27 occurs on P1.27/CAP0.1.	
	100	Start conversion when the edge selected by bit 27 occurs on MAT0.1.	
	101	Start conversion when the edge selected by bit 27 occurs on MAT0.3.	
	110	Start conversion when the edge selected by bit 27 occurs on MAT1.0.	
	111	Start conversion when the edge selected by bit 27 occurs on MAT1.1.	

Fig 1. A/D control register options

Problem:

The external start conversion feature, AD0CR:START = 0x2 or 0x3, may not work reliably and ADC external trigger edges on P2.10 or P1.27 may be missed. The occurrence of this problem is peripheral clock (pclk) dependent. The probability of error (missing a ADC trigger from GPIO) is estimated as follows:

- For PCLK_ADC = 72 MHz, probability error = 12 %
- For PCLK_ADC = 50 MHz, probability error = 6 %
- For PCLK_ADC = 12 MHz, probability error = 1.5 %

The probability of error is not affected by the frequency of ADC start conversion edges.

Work-around:

In software-controlled mode (BURST bit is 0), the START conversion options (bits 26:24 set to 0x1 or 0x4 or 0x5 or 0x6 or 0x7) can be used. The user can also start a conversion by connecting an external trigger signal to a capture input pin (CAPx) from a Timer peripheral to generate an interrupt. The timer interrupt routine can then start the ADC conversion by setting the START bits (26:24) to 0x1. The trigger can also be generated from a timer match register.

3.2 Core.1: Incorrect update of the Abort Link register in Thumb state

Introduction:

If the processor is in Thumb state and executing the code sequence STR, STMIA or PUSH followed by a PC relative load, and the STR, STMIA or PUSH is aborted, the PC is saved to the abort link register.

Problem:

In this situation the PC is saved to the abort link register in word resolution, instead of half-word resolution.

Conditions:

The processor must be in Thumb state, and the following sequence must occur:

```
<any instruction>  
<STR, STMIA, PUSH> <---- data abort on this instruction  
LDR rn, [pc,#offset]
```

In this case the PC is saved to the link register R14_abt in only word resolution, not half-word resolution. The effect is that the link register holds an address that could be #2 less than it should be, so any abort handler could return to one instruction earlier than intended.

Work-around:

In a system that does not use Thumb state, there will be no problem.

In a system that uses Thumb state but does not use data aborts, or does not try to use data aborts in a recoverable manner, there will be no problem.

Otherwise the workaround is to ensure that a STR, STMIA or PUSH cannot precede a PC-relative load. One method for this is to add a NOP before any PC-relative load instruction. However this would have to be done manually.

3.3 Ethernet.1: Ethernet TxConsumeIndex register does not update correctly after the first frame is sent

Introduction:

The transmit consume index register defines the descriptor that is going to be transmitted next by the hardware transmit process. After a frame has been transmitted hardware increments the index, wrapping the value to 0 once the value of TxDescriptorNumber has been reached. If the TxConsumeIndex equals TxProduceIndex the descriptor array is empty and the transmit channel will stop transmitting until software produces new descriptors.

Problem:

The TxConsumeIndex register is not updated correctly (from 0 to 1) after the first frame is sent. After the next frame sent, the TxConsumeIndex register is updated by two (from 0 to 2). This only happens the very first time, so subsequent updates are correct (even those from 0 to 1, after wrapping the value to 0 once the value of TxDescriptorNumber has been reached)

Work-around:

Software can correct this situation in many ways; for example, sending a dummy frame after initialization.

3.4 USB.1: USB host controller hangs on a dribble bit

Introduction:

Full-/low-speed signaling uses bit stuffing throughout the packet without exception. If the receiver sees seven consecutive ones anywhere in the packet, then a bit stuffing error has occurred and the packet should be ignored.

The time interval just before an EOP is a special case. The last data bit before the EOP can become stretched by hub switching skews. This is known as dribble and can lead to a situation where dribble introduces a sixth bit that does not require a bit stuff. Therefore, the receiver must accept a packet for which there are up to six full bit times at the port with no transitions prior to the EOP.

Problem:

The USB host controller will hang indefinitely if it sees a dribble bit on the USB bus. It will hang the first time a dribble bit is seen. Once it is in this state there is no recovery other than a hard chip reset. This problem has no effect on the USB device controller.

Work-around:

None.

3.5 VBAT.1: The VBAT pin cannot be left floating

Introduction:

The device has a VBAT pin which provides power only to the Real Time Clock (RTC) and Battery RAM. VBAT can be connected to a battery or the same supply used by rest of the device ($V_{DD(3V3)}$ pin, $V_{DD(DCDC)(3V3)}$ pin). The input voltage range on the VBAT pin is 2.0 V minimum to 3.6 V maximum for temperature $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$. Normally, if the RTC and the Battery RAM are not used, the VBAT pin can be left floating.

Problem:

If the VBAT pin is left floating, the internal reset signal within the RTC domain may get corrupted and as a result, prevents the device from starting-up.

Work-around:

The VBAT should be connected to a battery or the same supply used by rest of the device ($V_{DD(3V3)}$ pin, $V_{DD(DCDC)(3V3)}$ pin).

4. AC/DC deviations detail

4.1 IRC.1: Accuracy of the Internal RC oscillator (IRC) frequency may be outside of the 4 MHz $\pm$ 1 % specification only at extreme temperatures

Introduction:

The device has a 4 MHz internal RC oscillator (IRC) which can be optionally used as the clock source for the Watch Dog Timer (WDT), and/or as the clock that drives the PLL and subsequently the CPU. The IRC frequency spec is 4 MHz $\pm$ 1 % accuracy over the entire voltage and temperature range. During In-System Programming (ISP), the auto-baud routine is expecting the IRC frequency to be 4 MHz $\pm$ 1 % and is used to synchronize with the host via serial port 0.

Problem:

On the LPC247X Rev C device only, the accuracy of internal RC oscillator (IRC) frequency meets 4 MHz $\pm$ 1 % specification only at room temperature however, at extreme temperatures, the accuracy of internal RC oscillator (IRC) frequency may be 4 MHz $\pm$ 10 %. As a result, at extreme temperatures, this may affect the auto-baud routine's ability to synchronize with the host via serial port 0 during In-System Programming (ISP) at higher baud rates.

Work-around:

None

4.2 IRC.2: Accuracy of the Internal RC Oscillator (IRC) frequency for devices only with date codes 0949 and before are outside of the 4 MHz +/- 1 % specification only at temperatures between -20 °C and -40 °C

Introduction:

The device has a 4 MHz internal RC oscillator (IRC) which can be optionally used as the clock source for the Watch Dog Timer (WDT), and/or as the clock that drives the PLL and subsequently the CPU. The IRC frequency spec is 4 MHz +/- 1 % accuracy over the entire voltage and temperature range. During In-System Programming (ISP), the auto-baud routine is expecting the IRC frequency to be 4 MHz +/- 1 % and is used to synchronize with the host via serial port 0.

Problem:

On the LPC247X Rev D device (only with date codes 0949 and before), the accuracy of internal RC oscillator (IRC) frequency does not meet the 4 MHz +/- 1 % specification for temperatures between -20 °C and -40 °C and the accuracy of internal RC oscillator (IRC) frequency is 4 MHz +/- 5 % instead. As a result, only at these temperatures, this may affect the auto-baud routine's ability to synchronize with the host via serial port 0 during In-System Programming (ISP) at higher baud rates. For temperatures above -20 °C, the accuracy of internal RC oscillator (IRC) frequency meets the 4 MHz +/- 1 % specification.

Work-around:

None

5. Errata notes detail

5.1 Note.1

On each of the following port pins P0.23, P0.24, P0.25, P0.26, P1.30, P1.31, P0.12, and P0.13 (when configured as general purpose input pin (s)), leakage current increases when the input voltage is $V_i \geq V_{DD} I/O + 0.5 \text{ V}$. Care must be taken to limit the current to less than 4 mA by using a series limiting resistor.

5.2 Note.2

On the LPC2470/78 Rev D, design changes to the Memory Accelerator Module were made to enhance timing and general performance. Design changes are intended to enhance performance in general and will result in minor differences in the code execution timing between the previous device revisions and rev D. Actual performance impact is code dependent, some code sequences may speed up while other code sequences may slow down between the previous device revisions and rev D. This might be observed when using software delays and in such cases, a hardware timer should be used to generate a delay instead of a software delay.

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